





An ISO/TS 16949, ISO 9001 and ISO 14001 Certified Company

NPN SILICON PLANAR EPITAXIAL DARLINGTON TRANSISTORS



BCX38A BCX38B BCX38C

TO-92 Plastic Package

ABSOLUTE MAXIMUM RATINGS

DESCRIPTION	SYMBOL	VALUE	UNITS
Collector Emitter Voltage	V _{CEO}	60	V
Collector Base Voltage	V _{CBO}	80	V
Emitter Base Voltage	V _{EBO}	10	V
Peak Pulse Current	I _{CM}	2	А
Collector Current Continuous	I _C	800	mA
Power Dissipation @ T _a =25°C	P _D	625	mW
Operating and Storage Junction Temperature Range	T _j , T _{stg}	- 55 to +200	°C

ELECTRICAL CHARACTERISTICS (T_a=25°C unless specified otherwise)

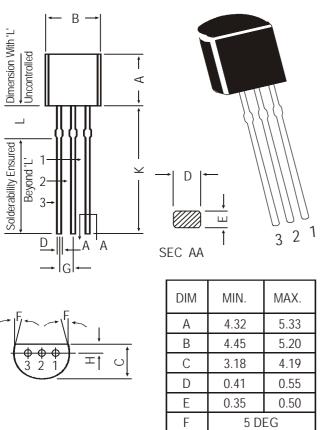
DESCRIPTION	SYMBOL	TEST CONDITION	MIN	MAX	UNITS
Collector Emitter Sustaining Voltage	V _{CEO (sus)}	$I_C=10$ mA, $I_B=0$	60		V
Collector Base Voltage	V_{CBO}	$I_{C}=10\mu A,\ I_{E}=0$	80		V
Emitter Base Voltage	V_{EBO}	$I_{E}=10\mu A, I_{C}=0$	10		V
Collector Cut off Current	I _{CBO}	$V_{CB} = 60V, I_{E} = 0$		100	nA
Emitter Cut off Current	I _{EBO}	$V_{EB}=8V$, $I_C=0$		100	nA
Collector Emitter Saturation Voltage	*V _{CE(sat)}	$I_C=800$ mA, $I_B=8$ mA		1.25	V
Base Emitter On Voltage	*V _{BE(on)}	I _C =800mA, V _{CE} =5V		1.80	V
DC Current Gain	*h _{FE}	BCX38A			
		I _C =100mA, V _{CE} =5V	500		
		I _C =500mA, V _{CE} =5V	1000		
		BCX38B			
		I _C =100mA, V _{CE} =5V	2000		
		I _C =500mA, V _{CE} =5V	4000		
		BCX38C			
		I _C =100mA, V _{CE} =5V	5000		
		I_C =500mA, V_{CE} =5V	10000		

^{*}Pulsed Conditions: Pulse Width = 300ms, Duty Cycle <2%

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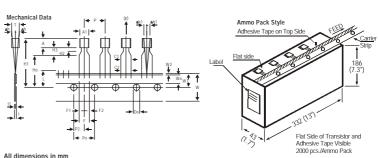
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TO-92 Transistors on Tape and Ammo Pack



G 1.14 1.40 Н 1.14 1.53 Κ 12.70 1.982 2.082

All diminsions in mm.



	SPI			ECIFICATION		
ITEM	SYMBOL	MIN.	NOM.	MAX.	TOL.	REMARKS
BODY WIDTH	A1	4.0		4.8		
BODY HEIGHT	A	4.8		5.2		
BODY THICKNESS	T	3.9		4.2		
PITCH OF COMPONENT	P		12.7		± 1.0	
FEED HOLE PITCH	Po		12.7		± 0.3	CUMULATIVE PITCH ERROR 1.0 mm/20 PITCH
FEED HOLE CENTRE TO						
COMPONENT CENTRE	P2		6.35		± 0.4	TO BE MEASURED AT BOTTOM OF CLINCH
DISTANCE BETWEEN OUTER					0.7	
LEADS	F		5.08		+ 0.6	
COMPONENT ALIGNMENT SIDE VIEW	Δh		0	1.0	- 0.2	AT TOP OF BODY
COMPONENT ALIGNMENT FRONT VIEW			0	1.3		AT TOP OF BODY
TAPE WIDTH	W		18		± 0.5	
HOLD-DOWN TAPE WIDTH	Wo		6		± 0.2	
HOLE POSITION	W1		9		+ 0.7	
					- 0.5	
HOLD-DOWN TAPE POSITION	W2		0.5		± 0.2	
LEAD WIRE CLINCH HEIGHT	Ho		16		± 0.5	
COMPONENT HEIGHT	H1			23.25		
LENGTH OF SNIPPED LEADS	L			11.0		
FEED HOLE DIAMETER	Do		4		± 0.2	
TOTAL TAPE THICKNESS	t			1.2		t1 0.3-0.6
LEAD - TO - LEAD DISTANCE	F1, F2		2.54		+ 0.4	
STAND OFF	H2	0.45		1.45	- 0.1	
CLINCH HEIGHT	H3	0.43		3.0		
LEAD PARALLELISM	C1 - C2			0.22		
PULL - OUT FORCE	(P)	6N				

- NOTES

 1. Maximum alignment deviation between leads will not to be greater than 0.2mm.

 2. Maximum non-cumulative variation between tape feed holes shall not exceed 1 mm in 20 pitches.

 3. Holddown tape will not exceed beyond the edge(s) of carrier tape and there shall be no exposure of adhesive.

 4. There will be no more than three (3) consecutive missing components in a tape.

 5. A tape trailier, having at least three feed holes are provided after the last component in a tape.

 6. Splices should not interfere with the sprocket feed holes.

Packing Detail

PIN CONFIGURATION

1. COLLECTOR 2. BASE

3. EMITTER

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PACKAGE	STANDARD PACK		INNER CARTON BOX		OUTER CARTON BOX				
	Details	Net Weight/Oty	Size	Qty	Size	Qty	Gr Wt		
TO-92 Bulk	1K/polybag	200 gm/1 K pcs	3" x 7.5" x 7.5"	5K	17" x 15" x 13.5"	80K	23 kgs		
TO-92 T&A	2K/ammo box	645 gm/2K pcs	12.5" x 8" x 1.8"	2K	17" x 15" x 13.5"	32K	12.5 kgs		

Notes

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Disclaimer

The product information and the selection guides facilitate selection of the CDIL's Discrete Semiconductor Device(s) best suited for application in your product(s) as per your requirement. It is recommended that you completely review our Data Sheet(s) so as to confirm that the Device(s) meet functionality parameters for your application. The information furnished in the Data Sheet and on the CDIL Web Site/CD are believed to be accurate and reliable. CDIL however, does not assume responsibility for inaccuracies or incomplete information. Furthermore, CDIL does not assume liability whatsoever, arising out of the application or use of any CDIL product; neither does it convey any license under its patent rights nor rights of others. These products are not designed for use in life saving/support appliances or systems. CDIL customers selling these products (either as individual Discrete Semiconductor Devices or incorporated in their end products), in any life saving/support appliances or systems or applications do so at their own risk and CDIL will not be responsible for any damages resulting from such sale(s).

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